

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	Conveyance of Rights
CONVEYING PARTY DATA	
Name	Execution Date
Siemens Energy, Inc.	07/30/2013
RECEIVING PARTY DATA	
Name:	Siemens Energy, Inc.
Street Address:	4400 Alafaya Trail
City:	Orlando
State/Country:	FLORIDA
Postal Code:	32826
Name:	Mikro Systems, Inc.
Street Address:	1180 Seminole Trail
Internal Address:	Suite 220
City:	Charlottesville
State/Country:	VIRGINIA
Postal Code:	22901
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13092303
CORRESPONDENCE DATA	
Fax Number:	4077366440
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	4077364045
Email:	luann.sweet@siemens.com
Correspondent Name:	Sandra Baker
Address Line 1:	Siemens Corporation
Address Line 2:	170 Wood Avenue South
Address Line 4:	Iselin, NEW JERSEY 08830

ATTORNEY DOCKET NUMBER:	2011P00224US
NAME OF SUBMITTER:	Luann Sweet
Signature:	/Luann Sweet/
Date:	08/13/2013
Total Attachments: 1 source=2011P00224US_COR_signed#page1.tif	

CONVEYANCE OF RIGHTS

WHEREAS Siemens Energy Inc. ("SEI"), a Corporation that was organized and exists under the laws of Delaware and has its principal place of business at 4400 Alafaya Trail, Orlando, Florida 32826, and Mikro Systems, Inc. ("MSI"), a Corporation that was organized and exists under the laws of Delaware and has its principal place of business at 1180 Seminole Trail, Suite 220, Charlottesville, VA 22901 (SEI and MSI collectively referred to herein as the "Parties"), entered into an agreement dated 29 April 2011 and titled the "Development and Manufacturing Agreement" (hereinafter the "Agreement") that sets forth certain rights, limitations, and obligations regarding certain subject matter developed by the Parties, and

WHEREAS SEI and MSI agree that the terms of the Agreement apply to certain subject matter that is disclosed in one or more applications for United States Letters patent entitled:

Patent Application Title: SERPENTINE COOLING CIRCUIT WITH T-SHAPED PARTITIONS IN A TURBINE AIRFOIL

Filing Date: April 22, 2011

Filing Number: 13/092,303

Internal Case Number: 2011P00224US

and to every continuation, continuation-in-part, continuing, divisional, reissue, substitute, renewal, extension, and any other application for Letters Patent that has been or ever is filed in the United States or in any foreign country that discloses any of said certain subject matter; and in and to every original and reissued patent that has been or ever is issued in the United States or in any foreign country that discloses any of said certain subject matter (all such applications and patents collectively referred to herein as the "Patents");

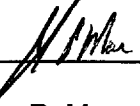
NOW THEREFORE, in consideration of the mutual covenants and agreements contained herein and in the Agreement and intending to be legally bound hereby, the parties agree to the following:

SEI hereby assigns to MSI (including any respective successors, assigns and legal representatives) certain rights, title, and interest in and to the Patents in accordance with the terms of the Agreement,

MSI hereby assigns to SEI (including any respective successors, assigns and legal representatives) certain rights, title, and interest in and to the Patents in accordance with the terms of the Agreement, and

SEI and MSI (including any respective successors, assigns and legal representatives) hereby agree to limit certain of their rights in and to the Patents in accordance with the terms of the Agreement.

Siemens Energy, Inc.

Signature 

Name: John P. Musone

Title: Assistant Secretary

Date: 31 July 2013

Mikro Systems, Inc.

Signature 

Name: Michael P. Appleby

Title: President and CEO

Date: JULY 29, 2013